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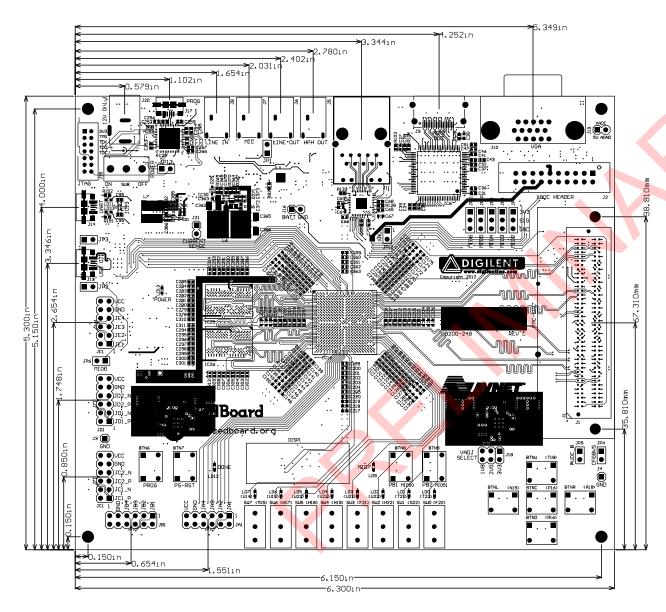
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njer no	Gerber Document	Copper Thickness	Dielectric Height	Dielectric Material	Dielectric Constant	Dielectric Type
op Solder Mask	(.GTS)		0.0102mm	Solder Resist	3.50	
op Layer	(.GTL)	0.0356mm				
ND2	(.GP1)	O. 0356mm	O.1mm	FR-4	4.80	Core
			0.125mm	FR-4	4.80	PrePreg
Mid-Layer 1	(.G1)	O. 017mm	0.125mm	FR-4	4.80	Core
Mid-Layer 2	(.G2)	0.017mm	O. 125mm	IR I	1.00	core
POWER1	(,GP2)	0.0356mm	0.125mm	FR-4	4.80	PrePreg
JUMERI	(.GP2)	U. U.356MM	0.35mm	FR-4	4.80	Core
POWER2	(.GP3)	O.0356mm				
MidLayer3	(.G3)	O. 017mm	0.125mm	FR-4	4.80	PrePreg
•			0.125mm	FR-4	4.80	Core
Mid-Layer 4	(.G4)	O. 017mm	O.125mm	FR-4	4, 80	PrePreq
GND7	(.GP4)	O. 0356mm				
Bottom Layer	(,GBL)	O. 0356mm	O.1mm	FR-4	4.80	Core
Jottom Lager	(.OBL)	O. 0330iiiii				
Bottom Solder Mask	(.GBS)		0.0102mm	Solder Resist	3.50	